DESIGN OF SNUBBERS FOR POWER CIRCUITS

By Rudy Severns

What's a snubber?

Power semiconductors are the heart of power electronics equipment. Snubbers are circuits which are placed across semiconductor devices for protection and to improve performance. Snubbers can do many things:

- · Reduce or eliminate voltage or current spikes
- · Limit dI/dt or dV/dt
- Shape the load line to keep it within the safe operating area (SOA)
- Transfer power dissipation from the switch to a resistor or a useful load
- · Reduce total losses due to switching
- Reduce EMI by damping voltage and current ringing

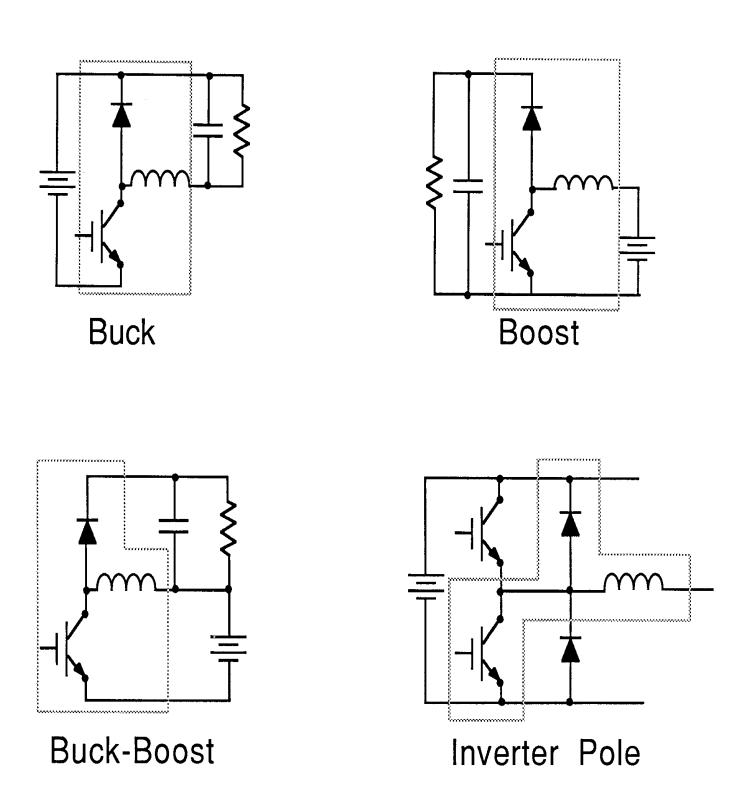
There are many different kinds of snubbers but the two most common ones are the resistorcapacitor (RC) damping network and the resistor-capacitor-diode (RCD) turn-off snubber. This application note will show you how to design these two snubbers.

Switching waveforms

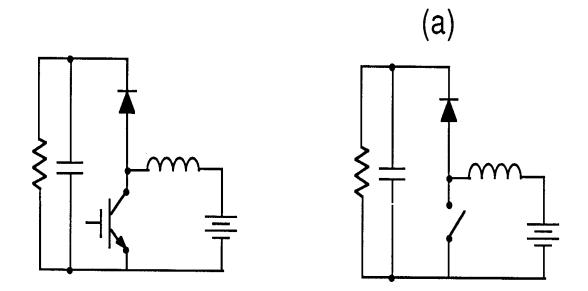
Before getting into the design of snubbers it is important to understand the waveforms which occur naturally in power circuits. These provide both the motivation for using snubbers and the information needed for their design. There are many different types of circuits used in power converters, motor drives, lamp ballasts and other devices. Fortunately all of these different circuits have a common network and waveforms associated with the switches. Figure 1 shows four widely used circuits. All of these circuits, and in fact most power electronics circuits, have within them the same switch-diode-inductor network shown within the dotted lines. The behavior of this network is the same in all these circuits which means that we only have to solve the snubber design problem for one circuit to apply it to all of the others. This tremendously simplifies the problem and allows generalized snubber design techniques.

A typical boost converter is shown in figure 2A. For snubber design we are concerned with circuit behavior during the switch transition time which is much shorter than the switching period. This allows us to simplify the analysis. In normal operation the output voltage is DC with very little ripple. This means that we can replace the load and filter capacitor with a battery since the output voltage changes very little during switch transitions. The current in the inductor will also change very little during a transition and we can replace the inductor with a current source. The simplified circuit is given in figure 2B. The voltage (E) and current (I) waveforms are given in figure 2C.

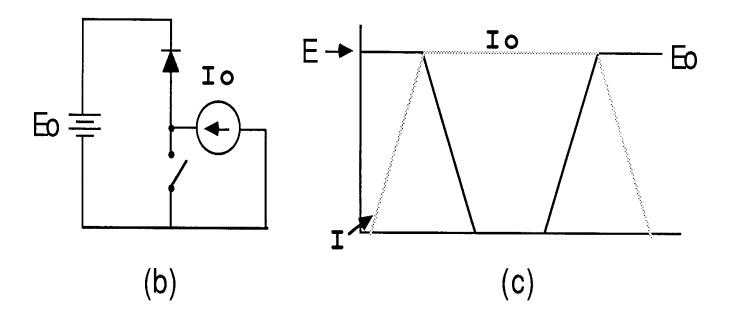
At the beginning of the switching cycle the switch is open and all of the current (I_0) will be flowing through the diode into the battery. As the switch turns on, the current will gradually shift from the diode to the switch. However, as long as there is



Boost Converter



.



current in the diode, the switch voltage will remain at E_0 . Once all of the current has been transferred to the switch, the switch voltage can begin to fall. At turn-off the situation is reversed. As the switch turns off, the voltage across it will rise. The current in the switch will however, not begin to fall until the switch voltage reaches E_0 because the diode will be reverse biased until that point. Once the diode begins to conduct the current in the switch can fall.

This type of switching, commonly referred to as "hard switching", exposes the switch to high stress because the maximum voltage and maximum current must be supported simultaneously. This also leads to high switching loss.

In practical circuits the switch stress will be even higher due to the unavoidable presence of parasitic inductance (L_p) and capacitance (C_s) as shown in figure 3A. C_p includes the junction capacitance of the switch and stray capacitance due to circuit layout and mounting. L_p is due to the finite size of the circuit layout and lead inductance. L_p can be minimized with good layout practice but there may be some residual inductance which may cause a ringing voltage spike at turn-off as shown in figure 3B.

The most common reasons for using a snubber are to limit the peak voltage across the switch and to reduce the switching loss during turn-off.

RC snubber design

An RC snubber, placed across the switch as shown in figure 4, can be used to reduce the peak voltage at turn-off and to damp the ringing. In most cases a very simple design technique can be used to determine suitable values for the snubber components (R_s and C_s). In those cases where a more optimum design is needed, a somewhat more complex procedure is used.

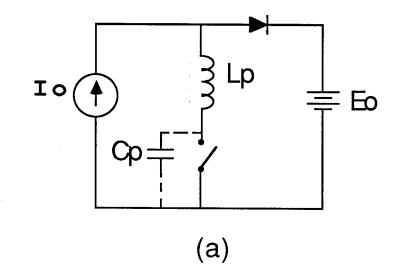
<u>Quick snubber design</u>: To achieve significant damping $C_s > C_p$. A good first choice is to make C_s equal to twice the sum of the output capacitance of the switch and the estimated mounting capacitance. R_s is selected so that $R_s = E_o/I_o$. This means that the initial voltage step due to the current flowing in R_s is no greater than the clamped output voltage. The power dissipated in R_s can be estimated from peak energy stored in C_s :

$$U_p = \frac{C_s E_0^2}{2}$$

This is the amount of energy dissipated in R_s when C_s is charged and discharged so that the average power dissipation at a given switching frequency (f_s) is:

$P_{diss} \approx C_s E_a^2 f_s$

Depending on the amount of ringing the actual power dissipation will be slightly higher than this.



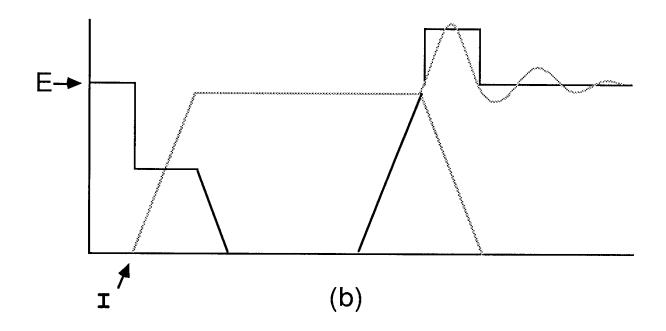
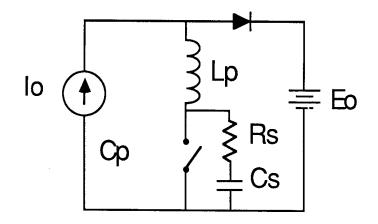


Figure 4



The following example shows how to use this procedure. Suppose the switch is an IRF740 with $I_o = 5$ A and $E_o = 160$ V. For this device $C_{oss} = 170$ pF and the mounting capacitance will be 40 pF. Doubling this capacitance, $C_s = 420$ pF. A 500V Snubber Mike capacitor would be ideal for this application and the standard values available are 390 and 470 pF. We will choose the closest standard value and set $C_s = 390$ pF. $R_s = E_o/I_o = 32W$. For $f_s = 100$ kHz, $P_{diss} = 1W$. A 2 Watt carbon composition resistor would be ideal for R_s because it has very low self inductance. Carbon film resistors can also be used as long as those resistors which are trimmed with a spiral cut are avoided.

If this very simple and practical procedure does not limit the peak voltage sufficiently then C_s can be increased or the optimizing procedure can be used.

<u>Optimized RC snubber</u>: In those cases where the peak voltage must be minimized and power dissipation is critical, a more optimum design approach should be used. In a classic paper [1] Dr. W. McMurray described the optimization of the RC snubber. The following discussion presents the highlights of the procedure.

ne following definitions will be used:					
$Z_{o} = (L_{p}/C_{s})^{1/2}$					
$\chi = (I_o/E_o)Z_o$	initial current factor				
$\chi^{2} = L_{p} L_{o}^{2} / C_{s} E_{o}^{2}$ Cs	initial energy in Lp/final energy in				
$\zeta = P_s/2Z_o$	damping factor				
E ₁ =	peak switch voltage				
$E_1/E_0 =$	normalized peak switch voltage				

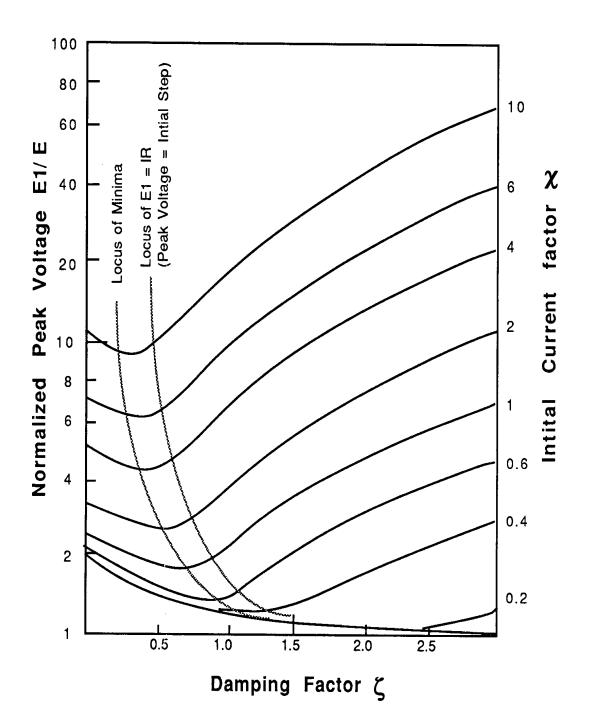
The following definitions will be used:

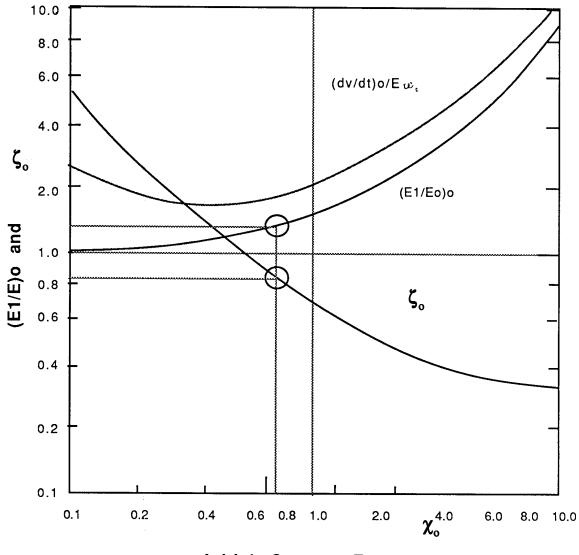
In the design process I_o , E_o and L_p will be given and it will be necessary to determine the values for Rs and Cs which give an acceptable peak voltage (E_1). Figure 5 shows the relationship between E_1/E_o and ζ for different values of χ . The key point which this graph makes is that for a given χ ($\chi \alpha 1/Cs^3$) there is an optimum value for ζ ($\zeta \alpha R_s$) which gives the lowest peak voltage. A second important point is that the lowest value of peak voltage attainable is determined by the size of C_s . If a lower peak voltage is required, then a larger C_s must be used. This means that the power dissipation has to increase as the peak voltage is reduced.

The design of an optimized RC snubber is very easy using the graph given in figure 6. The design proceeds in the following steps:

1. Determine I_0 , E_0 and L_p

2. Select the maximum peak voltage





Initial Current Factor

- 3. Compute E_1/E_0
- 4. From the graph, determine the values for χ and ζ
- 5. Given χ and ζ calculate the values for R_s and C_s

Here is an actual example. If $I_o = 5 \text{ A}$, $E_o = 300 \text{ V}$, $L_p = 1\mu\text{H}$ and $E_1 = 400\text{V}$ then $E_1/E_o = 1.33$. Following the dashed line and arrows on figure 6, $\chi_0 = 0.65$ and $\zeta_0 = .8$. From this information R_s and C_s can be determined:

$$C = \left(\frac{I_o}{E_o}\right)^2 \left(\frac{L_p}{\chi_o^2}\right) = 657 pF$$
$$R_s = 2\varsigma_o \sqrt{\frac{L_p}{C_s}} = 614\Omega$$

using a standard CDE "Snubber Mike" capacitor let $C_s = 680 pF$ using a standard resistor let $R_s = 62$ Ohms

The graphs (figures 5 and 6) do not take into account the effect of the switch shunt capacitance or finite transition time. In general the optimum value for R_s will be somewhat lower than calculated. A more precise optimum can be achieved by simulation of the switching with SPICE. Starting with the computed values, R_s can then be easily varied to find the optimum. In general the optimum will be quite broad allowing the use of standard 5% resistor values.

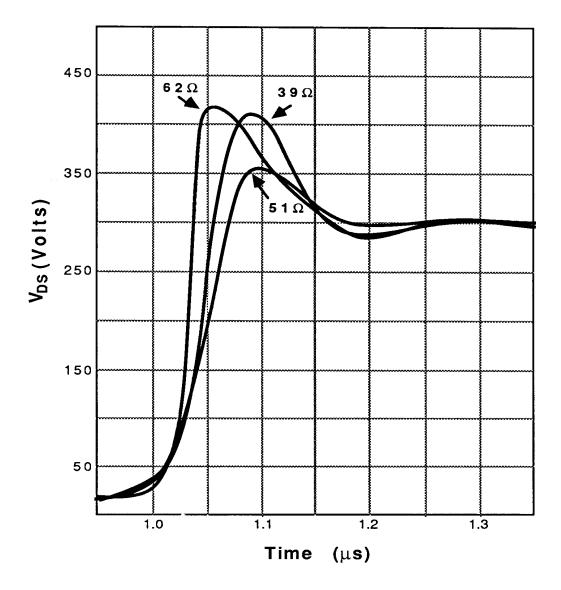
An example of optimizing R_s , using an IRF840 for the switch, is shown in figure 7. The optimum value for $R_s = 51$ Watts and $E_1 = 363$ V. For $R_s = 39$ and 62 Watts, E_1 is higher. The final peak voltage is less than 400 V because of the shunt capacitance of the switch. If E_1 is allowed to rise to 400 V then a smaller value for C_s could be used, saving some power dissipation.

This example shows the importance of simulating and optimizing the snubber circuit using the actual components. The graphs get you into the ball park and the simulation allows for optimization.

<u>Determination of L</u>_p:

 E_o and I_o come directly from the circuit. The value for E_1 is a judgment call and will depend on the voltage rating of the switch and the voltage derating factor. The designer must choose the peak acceptable voltage. All of these quantities are fairly obvious. L_p however, is a characteristic of the particular circuit layout and is not usually easy to calculate. L_p can be determined from the circuit by measuring the period of one ringing cycle (T₁), then adding a known capacitor (C_{test}) in parallel with the switch and finally re-measuring the period (T₂). L_p can be computed from:

$$L_p = \left(T_2^2 - T_1^2\right) \left(\frac{1}{4\pi^2 C_{test}}\right)$$



Usually Ctest is approximately equal to twice the switch capacitance

An alternate method for determining L_p in higher power circuits is to take advantage of the voltage step (V_{step}) which appears in V_{ce} or V_{ds} due to the dI/dt of the current flowing in L_p at turn-on:

$$L = \left(\frac{V_{step}}{di/dt}\right)$$

At switch turn-on C_s will be charged. This means that there will be a current spike in the switch due to the discharge of C_s through R_s in addition to the normal current flow. This is a short transient pulse which rapidly decays but it can add substantially to the turn-on current and should be taken into account. It should be noted that the RCD snubber discussed in the next section will also have this turn-on current spike but that spike can be controlled more easily because the value for R_s does not have to be optimized for maximum damping.

RC snubbers are very useful for low and medium power applications but when the power level is more than a few hundred watts the loss in the snubber can be excessive and other types of snubbers need to be considered. The RC snubber does have a place in high power applications as a secondary damping network to suppress high frequency ringing which does not have a lot of energy associated with it.

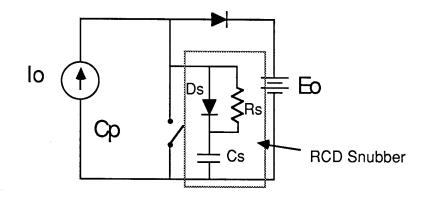
RCD snubber design

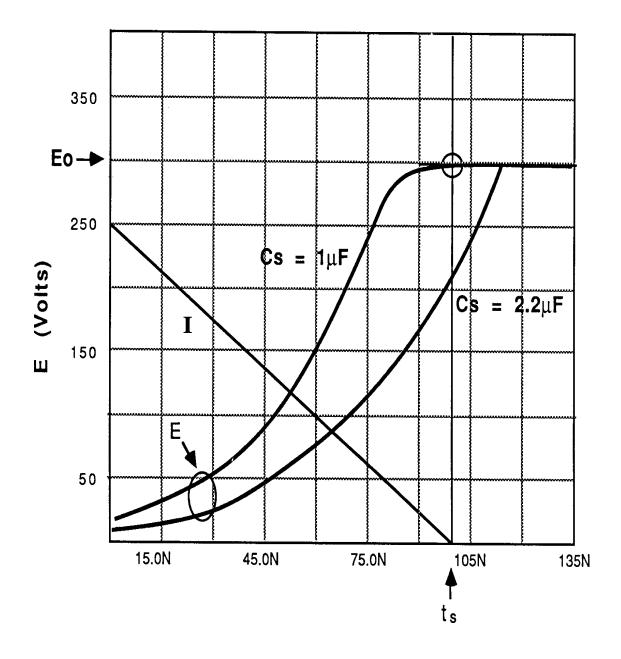
The RCD snubber as shown in figure 8 has several advantages over the RC snubber:

- In addition to peak voltage limiting, the circuit can reduce the total circuit loss, including both switching and snubber losses.
- Much better load lines can be achieved, allowing the load line to pass well within the SOA.
- For a given value of C_s , the total losses will be less
- The shunt capacitance across the switch (C_p) is a useful part of the snubber

There is one disadvantage however. Because of the diode across R_s , the effective value for R_s , during the charging of C_s , is essentially zero. This is not the optimum value and, for a given C_s , E_1 will be higher than it would be in an optimized RC snubber.

Typical turn-off waveforms for this snubber are given in figure 9. These waveforms assume that $L_p = 0$. The effect of L_p will be considered shortly. The key feature of these waveforms is that the switch voltage rises slowly as the switch current falls. This means that the high peak power associated with





simultaneous maximum voltage and current is eliminated. The net result is much lower peak stress and switching loss. Voltage waveforms for two different values of C_s are shown. In this example $I_o = 10$ A and $E_o = 300$ V. As C_s is made larger the peak power and the switching loss will be lower. However, larger C_s means greater loss in R_s when the switch turns on and C_s is discharged through R_s and the switch. Again we see the tradeoff between snubber efficacy and loss.

Depending on the size of C_s the switch voltage may reach E_o before, at the same time, or after the switch current reaches zero. The case where $E = E_o$ at the instant that I = 0 is defined as a "normal" snubber and $C_s = C_n$, where $E = C_n$, where $E = E_o$ at the instant that I = 0 is defined as a "normal"

$$C = \frac{I_0 t_s}{2E_o}$$

Where t_s is the fall time of the switch current (see figure 9). For the example given in figure 9, $C_n = 1.667$ nF.

The relationships between C_n , switching loss, peak switch stress, snubber loss and total loss are shown in figure 10. Snubber size is shown relative to C_n . When even a small snubber is used ($C_s < C_n$) the switching loss drops quickly. As C_s is made larger however, the improvement in switch loss decreases. For example, for $C_s = C_n$, the switch loss is down to 16%. Making C_s larger will reduce the switching loss only a small amount but will increase the snubber loss substantially. There is in fact a broad minimum loss around $C_s = 0.45 C_n$, where the total loss is reduced to 53% of what it would have been without the snubber. It is important to remember that C_p is part of C_s and that the actual value for $C_s = .45 C_n - C_p$. For $C_s / C_n = 2$ the total loss is equal to what it would have been if no snubber were used, however the switching load line will have very low stress.

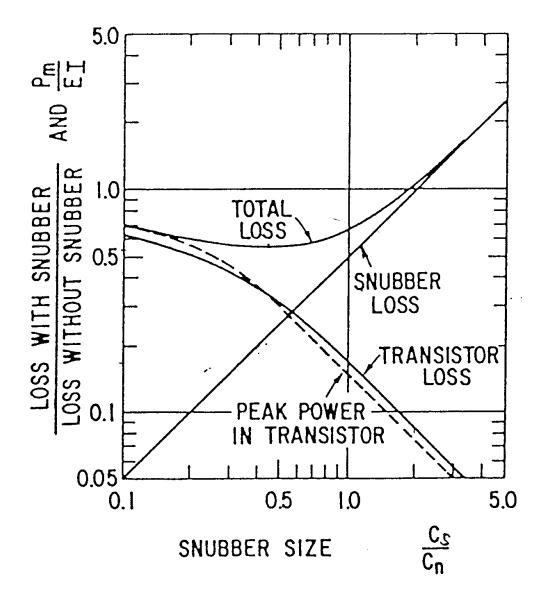
In those cases where the primary concern is to reduce the total switching loss, the value for C_s is usually set to .5 Cn. In this case R_s is selected to allow the voltage on C_s to decay to a small value during the minimum switch on time ($t_{on,min}$). The capacitor voltage decay is a simple RC exponential and in two time constants ($\tau = R_s C_s$) will be down to 0.14 E_o . This is usually sufficient. The value of R_s is then:

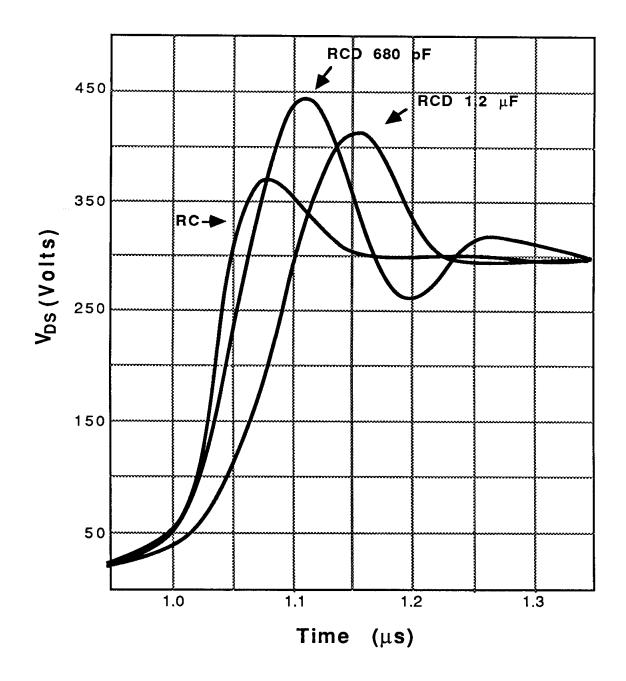


When L_p is significant there will be voltage overshoot during turn-off. If E_1 must be controlled then different values for C_s may be necessary and a compromise made. Figure 11 gives a comparison between the RC snubber developed earlier and an RCD snubber using the same component values ($R_s = 51W$ and $C_s = 680$ pF). Note that the loss will be lower but the peak voltage is higher for the RCD snubber. This is typical. For similar total loss, C_s can be larger in the RCD snubber which will reduce E_1 . Increasing C_s to 1.2 nF reduces E_1 to 424 V. C_s could be increased further but for the same total loss, E_1 will still be higher in the RCD snubber.

<u>Combined snubber</u>: When it is important to minimize both the loss in the switch and E_1

Figure 10





a combination snubber, using both RC and RCD, can produce very good results with low losses. An example of such a combination is given in figure 12 and the resulting waveform is compared to the previous RC snubber, using the same circuit conditions, in figure 13.

Component selection and layout

The components in snubbers can be very highly stressed and must therefore be selected with some care.

Layout and inductance

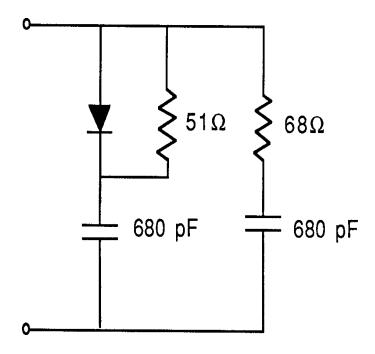
One of the primary reasons for using snubbers is the presence of parasitic inductances (L_p) in the circuit which generate voltage spikes and ringing when excited by the switching action. Larger parasitic inductance means larger snubber components and more dissipation. Before actually designing the snubber, it is important to minimize the circuit parasitic inductances and careful circuit layout is the key. As power levels rise this becomes progressively more important because of the increasing dI/dt.

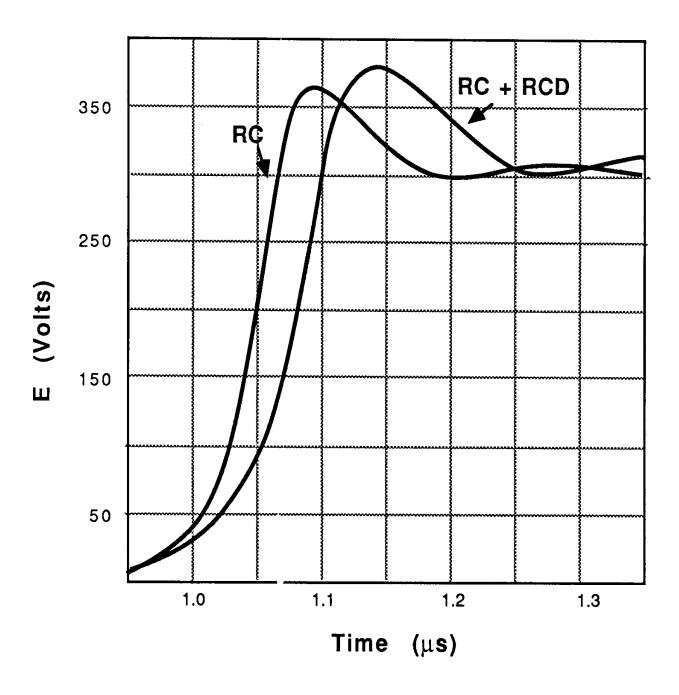
Figure 14A illustrates a typical inverter pole or converter half-bridge. The bus which connects the source (V_{dc}) to the "+" and "-" ends of the pole will have some inherent inductance, both in the bus structure and in the energy storage capacitors (C₁, ESL). The effect of L_p can be greatly reduced by placing smaller, low ESL, capacitors as close as possible to the switches as shown by C₂. One possibility is to use CDE snubber capacitor modules which connect directly to the IGBT module as shown in figure 15. These modules are available as either a simple capacitor or they may include one or more snubber diodes to implement an RCD snubber.

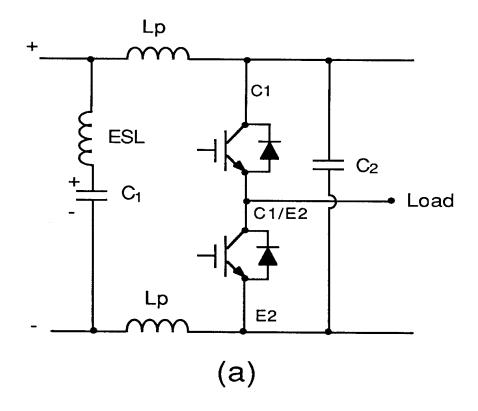
In some cases the addition of C_2 by itself may not be a complete answer because the bus voltage may ring due to the resonance of Lp, C_1 and C_2 . An alternative is to use an RCD snubber as a clamp as shown in figure 14B. The average voltage across C_2 will be equal to the bus voltage. At turn-off the voltage across C_2 will rise as it limits the peak switch voltage but later in the cycle the voltage is reset to the bus voltage through R_S . R_S also damps the bus voltage ringing. An additional advantage of this approach is that L_p acts as a turn-on snubber, reducing turn-on switching loss.

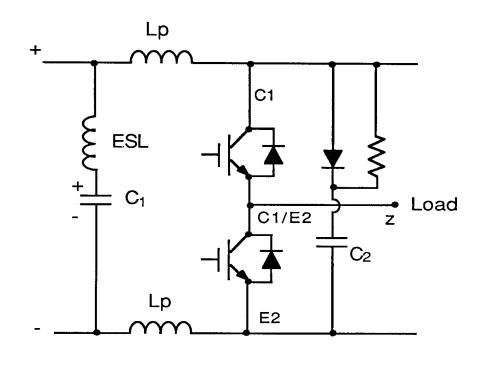
Because of the very large dI/dt's which are common in snubbers, small amounts of parasitic inductance within the snubber can interfere with snubber action leading to higher than expected peak voltages. Parasitic inductance comes from two sources: intrinsic to the components due to physical size and lead configuration and from the layout. Component inductance can be minimized by the choice of package (radial versus axial for example) and can be further reduced by using several smaller devices in parallel. Paralleling is particularly useful in high power snubbers because in addition to allowing lower inductance configurations, it can improve the surface area-volume ratio allowing better cooling and higher rms currents.

The primary source of layout inductance is the connection from the snubber components to the switch. The snubber components should be placed as close as possible to the switch terminals. The components should be arranged so that the current









(b)

loop formed by the snubber has a small an area (low inductance!) as possible. The CDE snubber modules shown in figure 15 are a very good example. With these modules, the snubber is connected directly across the switch terminals with low inductance strap leads.

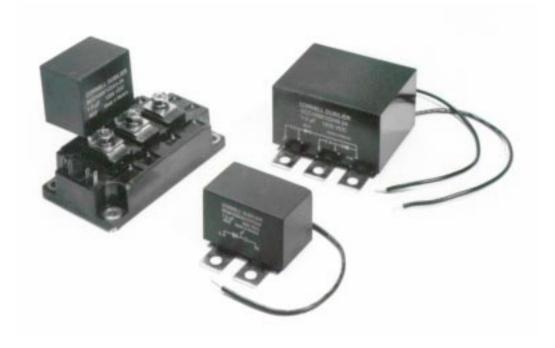
<u>Capacitor selection</u>: Snubber capacitors are subjected to high peak and rms currents and high dV/dt. An example of the turn-on and turn-off current spikes in a typical RCD snubber capacitor is given in figure 16. The pulses have high peak and rms amplitudes. CDE has several types of capacitors which are particularly well suited to snubber applications. Table 1 shows the various types and characteristics of capacitors intended for snubber applications.

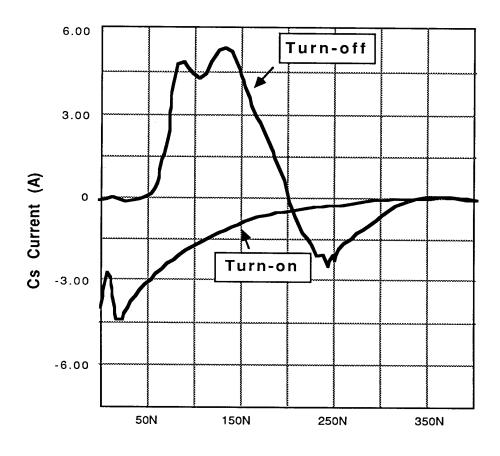
STYLE	PACKAGE	DIELECTRIC	ELECTRODE	VOLTS RANGE	CAP RANGE	dV/dt	Irms
CD16 CDV16 CDV19 CD30 CDV30	Dipped with radial leads	Mica	Foil	500-1500 VDC	100-10,000 pF	>10,000 V/µs	Up to 9 A
WPP	Wrap & Fill axial leads	Polypropylene	Foil	250-1000 VDC	0.001-2.0 µF	300-10,000 V/µs	Up to 10 A
DPF DPP	Wrap & Fill axial leads	Polypropylene	Foil	250-2000 VDC	0.01-0.47 µF	3000-10,000 V/μs	Up to 10 A
SCD	Box type, direct mount to IGBT	Polypropylene	Double Metallized	600-2000 VDC	0.1-10 µF	100-2000 V/µs	Up to 50 A
940 941	Wrap & Fill axial leads	Polypropylene	Double Metallized	600-3000 VDC	0.1-4.7 µF	100-2000 V/µs	Up to 25 A
942 943	Wrap & Fill axial leads	Polypropylene	Hybrid- metallized PP/ Foil	600-2000 VDC	0.1-4.7 µF	500-5000 V/µs	Up to 25 A

 Table 1

 Cornell Dubilier Capacitors for Snubber Applications

<u>Resistor selection</u>: As pointed out earlier, it is important that R_s , in an RC snubber, have low self inductance. Inductance in R_s will increase the peak voltage (E₁) and tend to defeat the purpose of the snubber. Low inductance is also desirable for R_s in an RCD snubber but is not as critical since the effect of a small amount of inductance is to slightly increase the reset time of C_s and reduce the peak current somewhat in the switch at turn-on. The normal choice for Rs is usually carbon composition or metal film. For higher power levels low inductance wire wound resistors, such as the Dale Electronics NH types, can be used with some care to verify the actual residual inductance and its effect on the snubber action. Again, it is in the RC snubbers that parasitic inductance is most critical.





Time (ns)

<u>Diode selection</u>: The diode in an RCD snubber has to be rated for at least the peak voltage which appears on C_s . In general the average current in the diode is relatively small but the peak currents are substantial. The peak current should be the basis for selecting the diode. The diode reverse recovery time (t_{rr}) can effect the snubber action and fast or ultra-fast diodes with $t_{rr} < 100$ ns are normally used. The performance of the diode should be verified in the circuit to be sure the snubber is performing as expected.

As the voltage rating of the diode is increased and faster recovery diodes are selected, the forward recovery time (t_{fr}) may become a consideration. This is because the initial voltage drop across the diode, in the forward direction, can be much higher than the steady state conduction value for several hundred nsec. This problem is exacerbated by the very high dI/dt of typical snubber current waveforms. By the time the diode is fully turned on, the snubber current pulse may be long finished. It may be necessary to try several different device types in the actual circuit to get satisfactory performance.

Snubbers for IGBT inverters

IGBTs are increasingly the switch of choice for inverters used in power electronics applications. IGBTs are replacing MOSFETs in many high voltage, hard switching applications since they have lower conduction losses and smaller die area for the same output power. The smaller die size translates to lower cost and smaller input capacitance. Most IGBT modules are used in hard switching applications of up to 20 KHz. Beyond that, switching losses in the IGBT become very significant.

Switching such high currents in a short time gives rise to voltage transients that could exceed the rating of the IGBT especially if the bus voltage is close to the IGBT's voltage rating. The magnitude of the voltage transient is given by: $L_s \frac{di}{dt}$

where: Ls is the 'DC loop' inductance di/dt is the rate of change of current with time

Design engineers are encouraged to minimize the 'DC loop' inductance. The use of laminated bus bars and improving circuit layout are ways of significantly reducing bus inductance; yet parasitic inductance will still be present. Snubbers are therefore needed to protect the switch from transients resulting from current changing in the parasitic inductance. In addition to providing protection from overvoltage, snubbers can be employed to:

- ° Limit dI/dt or dV/dt
- [°] Shape the load line to keep it within the safe operating area (SOA)
- [°] Transfer power dissipation from the switch to a resistor
- ° Reduce total switching losses
- [°] Reduce voltage and current ringing

There are three basic types of snubbers circuits used in IGBT applications. The type used will depend largely on the power level, switching frequency, and circuit layout. Figure 18 shows these snubber circuits and how they are applied to a half bridge rectifier.

The de-coupling is the simplest of the three types. It is essentially a low inductance capacitor mounted across the bus, from C to E on a dual IGBT module, or from P to N on a six pack. The de-coupling is effective in reducing transients by providing a low inductance path during switching operation. De-coupling caps are typically used in low to medium current applications. In higher current applications, oscillations between the source and the de-coupling capacitor will produce ripple current that may cause the capacitor to fail.

Cornell Dubilier offers 940, 941, and SCD (Direct mount) capacitors for de-coupling applications. The 940 series capacitors are axial leaded and can be mounted onto a PCB while style SCD caps are mounted directly to the IGBT module. Direct mount types have lower inducatance due to the flat, radial lead geometry. They are easy to install using the IGBT's own screws. Direct mount capacitors are rated for higher current because heavy copper lugs are connected directly to the capacitor element.

The value of the capacitance needed for a de-coupling application depends on the stray inductance, maximum switching current, allowable peak voltage and dc bus voltage. The Snubber capacitance needed can be approximated from the following:¹⁶

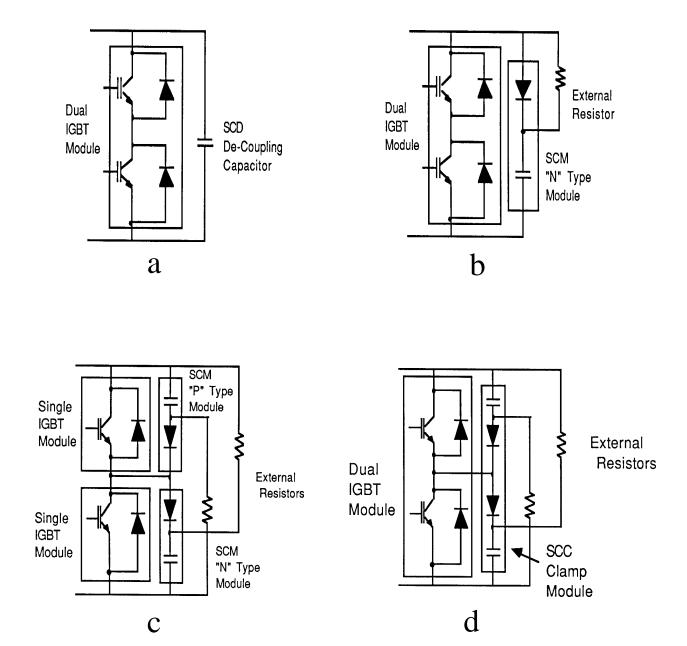
$$C_s = \frac{LsI_o^2}{(V_{pk} - V_{cc})}$$

The difficulty in applying this formula is that bus inductance is often difficult to determine. Pages 10 through 12 of this application note provide a couple of methods for determining L. A good rule of thumb is to use 1 μ F per

100 A of IGBT if inducatance cannot be determined directly.

RCD snubbers are typically used in medium to high current applications. Direct mount snubbers containing hyperfast, soft recovery diodes are available from Cornell Dubilier. Style SCM may be used to protect dual IGBT modules by connecting them across the C and E terminals of the IGBT. See figure 18B. This snubber operates on the same principles as the de-coulping capacitor, but only during turn-off switching. As the IGBT turns off, energy trapped in the loop inductance is transferred to the capacitor. The diode blocks oscillations and the excess charge on the capacitor is dissipated through the external resistor.

In higher current applications where the inverter is made of two single IGBT modules, "P" type and "N" type SCM snubbers may be applied to clamp the inverter voltage as shown in figure 18C. Dual IGBT modules may also be protected using an SCC style "clamp" module as shown in figure 18D. At turn off, the snubber diode is forward biased and the snubber is activated. The energy trapped in the stray inductance is absorbed by the snubber capacitor. During turn-on the snubber caps that were fully charged to bus voltage have a discharge path through the forward bias free-wheel diode, the IGBT, and the snubber resistor. This reduces the reverse recovery voltage transient.



As the need for high power snubbers continues to increase, so does the need for information regarding appropriate component selection. This paper discussed the major types of snubbers, their application and methods for determining snubber component values. Use of these methods should lead to good component choice and ultimately good snubber design.

References

[1] William McMurray, OPTIMUM SNUBBERS FOR POWER SEMICONDUCTORS, IEEE IAS transactions, Vol. IA-8, No. 5, Sept/Oct 1972, pp. 593-600

[2] William McMurray, SELECTION OF SNUBBERS AND CLAMPS TO OPTIMIZE THE DESIGN OF TRANSISTOR SWITCHING CONVERTERS, IEEE IAS transactions, Vol. IA-16, No. 4, July/ August 1980, pp. 513-523

[3] Motto, E., EVALUATING THE DYNAMIC PERFORMANCE OF HIGH CURRENT IGBT MOD-ULES

[4] Kurnia, Stielau, Venkataramanan and Divan, LOSS MECHANISMS IN IGBT'S UNDER ZERO VOLTAGE SWITCHING, IEEE APEC 92 proceedings, pp. 1011-1017

[5] Wang, Lee, Hua and Borojevic, A COMPARATIVE STUDY OF SWITCHING LOSSES OF IGBT'S UNDER HARD-SWITCHING, ZERO-VOLTAGE-SWITCHING AND ZERO-CURRENT-SWITCH-ING, IEEE PESC 94 proceedings, pp. 1196-1204

[6] Johansen, Jenset and Rogne, CHARACTERIZATION OF HIGH POWER IGBT'S WITH SINEWAVE CURRENT, IEEE TRANSACTIONS ON INDUSTRY APPLICATIONS, VOL. 30, No. 5, September/October 1994, pp. 1142-1147

[7] Udeland, T., SWITCHING STRESS REDUCTION IN POWER TRNSISTOR CONVERTERS, IEEE IAS annual meeting proceedings, 1976, pp. 383-392

[8] Domb, M., NONDISSIPATIVE TURN-OFF SNUBBER ALLEVIATES SWITCHING POWER DISSIPATION, SECOND-BREAKDOWN STRESS AND V_{CE} OVERSHOOT, IEEE PESC proceedings, 1982, pp. 445-454

[9] Zach, Kaiser, Kolar and Haselsteiner, NEW LOSSLES TURN-ON AND TURN-OFF (SNUBBER) NETWORKS FOR INVERTERS, INCLUDING CIRCUITS FOR BLOCKING VOLTAGE LIMITA-TION, IEEE TRANSACTIONS ON POWER ELECTRONICS, VOL. PE-1, NO. 2, April 1986, pp. 65-75 [10] Bendien, Van Der Broeck and Fregien, RECOVERY CIRCUIT FOR SNUBBER ENERGY IN POWER ELECTRONIC APPLICATIONS WITH HIGH SWITCHING FREQUENCIES, IEEE TRANSACTIONS ON POWER ELECTRONICS, VOL. 3, NO. 1, January 1988, pp. 26-30

[11]Simonelli, and Torrey, AN ALTERNATIVE BUS CLAMP FOR RESONANT DC-LINK CON-VERTERS, IEEE TRANSACTIONS ON POWER ELECTRONICS, VOL. 9, NO. 1, January 1994, pp. 56-63

[12] Finney, Williams and Green, RCD SNUBBER REVISITED, IEEE TRANSACTIONS ON IN-DUSTRY APPLICATIONS, VOL. 32, NO. 1, January 1996, pp. 155-160

[13] McMurray, W., EFFICIENT SNUBBERS FOR VOLTAGE-SOURCE INVERTERS, IEEE PESC 85 proceedings, 1985, pp. 20-27

[14]Swanepoel and van Wyk, ANALYSIS AND OPTIMIZATION OF REGENERATIVE LINEAR SNUBBERS APPLIED TO SWITCHES WITH VOLTAGE AND CURRENT TAILS, IEEE TRANS-ACTIONS ON POWER ELECTRONICS, VOL. 9, N0. 4, July 1994, pp. 433-441

[15] Pearson and Sen, DESIGNING OPTIMUM SNUBBER CIRCUITS FOR THE TRANSISTOR BRIDGE CONFIGURATION, POWERCON 9 proceedings, 1982, pp. D-2-1 through D-2-11

[16] Zhang, Sobhani and Chokhawala, SNUBBER CONSIDERATIONS FOR IGBT APPLICA-TIONS, INTERNATIONAL RECTIFIER DESIGNER'S MANUAL, IGBT-3, TPAP-5, 1995, pp. E135-E144.